

### Features

- 40-bit Serial to Parallel Converter
- 20-bit Multiplexer for TX Control bits
- Serial Out Ports for Diagnostics and Daisy Chaining
- Compatible with 5.0 V and 3.3 V CMOS Logic
- Built-in Active Pull-down for Logic Inputs
- Fast Switching
- Low Current consumption
- Lead-Free 6 mm 48-lead PQFN Package
- Halogen-Free “Green” Mold Compound
- RoHS\* Compliant and 260°C Reflow Compatible

### Description

The MADR-011007 is a 40-bit serial to parallel driver in a low cost 6 mm 48-lead PQFN plastic package. It is designed as the serial control interface for MACOM’s transmit module MAIA-010365 and receive module MAIA-009579. A 20-bit multiplexer is designed on-chip to provide TX bits control capability. High speed digital CMOS technology is utilized to achieve low power dissipation. Even though it is designed to drive GaAs FETs using a -5 V power supply, it can also be used as a general serial to parallel converter when using a +5 V power supply.

This driver, used in conjunction with MACOM’s MAIA-010365 S-Band radar transmit module, MAAP-011022 S-Band 7 W high power amplifier, and the MAIA-009579 receiver, provides a complete chipset for S-Band dual polarization air traffic control and weather radar applications.

### Ordering Information<sup>1</sup>

Part Number	Package
MADR-011007-TR0500	500 piece reel

1. Reference Application Note M513 for reel size information.

### Pin Configuration

Pin No.	Function	Pin No.	Function
1	TX2-phase 1	25	RX2-atten 4
2	TX1-phase 1	26	RX1-atten 4
3	TX1-phase 2	27	RX1-atten 3
4	TX1-phase 3	28	RX1-atten 2
5	TX1-phase 4	29	RX1-atten 1
6	TX1-phase 5	30	RX1-phase 6
7	TX1-phase 6	31	RX1-phase 5
8	TX1-atten 1	32	RX1-phase 4
9	TX1-atten 2	33	RX1-phase 3
10	TX1-atten 3	34	RX1-phase 2
11	TX1-atten 4	35	RX1-phase 1
12	TX2-atten 4	36	RX2-phase 1
13	TX2-atten 3	37	RX2-phase 2
14	TX2-atten 2	38	RX2-phase 3
15	TX2-atten 1	39	RX2-phase 4
16	TX2-phase 6	40	RX2-phase 5
17	GND	41	LOAD
18	VEE	42	CLK
19	TX_STATE	43	SER_IN
20	SNGL_DUAL	44	SER_OUT
21	RX2-phase 6	45	TX2-phase 5
22	RX2-atten 1	46	TX2-phase 4
23	RX2-atten 2	47	TX2-phase 3
24	RX2-atten 3	48	TX2-phase 2
		49	Paddle <sup>2</sup>

2. The exposed paddle centered on the package bottom must be either left "open" (no connection) or connected to V<sub>EE</sub>.

\* Restrictions on Hazardous Substances, European Union Directive 2011/65/EU.

## 40-bit Serial to Parallel Driver for GaAs FETs

Rev. V2

Guaranteed Operating Ranges<sup>3,4,5</sup>

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{EE}^6$	Negative DC Supply Voltage	-5.5	-5.0	-4.5	V
$T_{OPER}$	Operating Temperature	-40	25	85	°C
$I_{OH}$	DC Output Current - High	-1	—	—	mA
$I_{OL}$	DC Output Current - Low	—	—	1	mA

3. Unused logic inputs must be tied to either GND or  $V_{EE}$ .

4. 0.01  $\mu$ F decoupling capacitors are required on the power supply line.

5. This driver can also operate at  $-3.3$  V  $V_{EE}$ , but at slower speed.

6. When using positive logic, GND should be connected to positive power supply +5 V, and  $V_{EE}$  should be connected to ground.

## Performance over Guaranteed Operating Range

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{IH}$	Input High Voltage	Guaranteed High Input Voltage	-1.5	0.0	0.0	V
$V_{IL}$	Input Low Voltage	Guaranteed Low Input Voltage	-5.5	-5.0	-3.5	V
$V_{OH}$	Output High Voltage	$I_{OH} = -250 \mu A$	—	-0.1	—	V
$V_{OL}$	Output Low Voltage	$I_{OL} = 250 \mu A$	—	$V_{EE} + 0.1$	—	V
$I_{IN}$	Input Leakage Current (per Input)	$V_{IN} = GND$ or $V_{EE}$	—	80	—	$\mu A$
$I_{OH}$	DC Output Current-High (per Output)	$V_{EE} = -5.0$ V	-1	—	—	mA
$I_{OL}$	DC Output Current-Low (per Output)	$V_{EE} = -5.0$ V	—	—	1	mA
$I_{EE}$	Quiescent Supply Current	$V_{IN} = GND$ or $V_{EE}$ , No Output Load	—	—	400	$\mu A$
$T_D$	Propagation Delay	50% LOAD signal to 90% $V_O$	—	12	—	ns
$C_{IN}$	Input Capacitance	—	—	6	—	pF

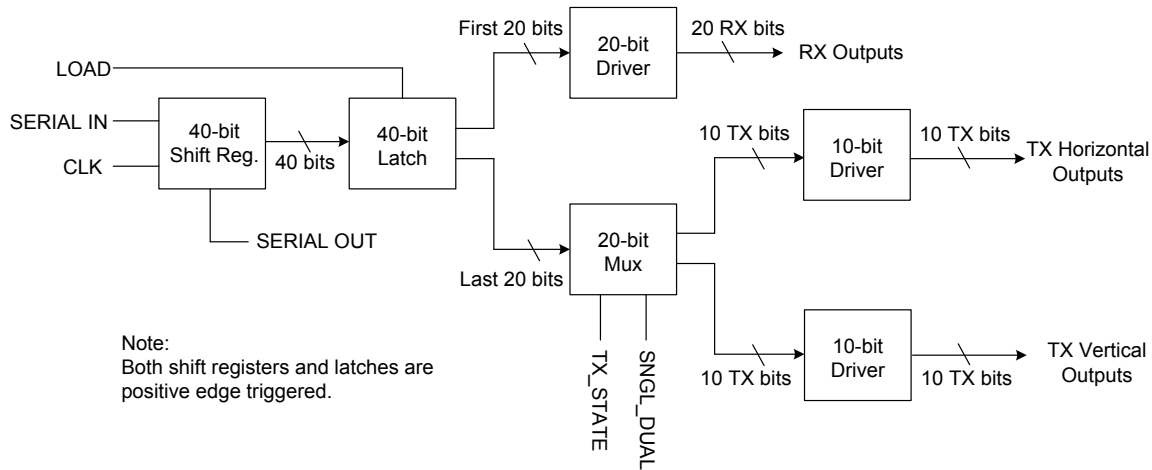
## Absolute Maximum Ratings

Symbol	Parameter	Min.	Max.	Unit
$V_{EE}$	Negative DC Supply Voltage	-7.0	0.3	V
$V_{IN}$	DC Input Voltage	$V_{EE} - 0.3$	0.3	V
$V_O$	DC Output Voltage	$V_{EE} - 0.3$	0.3	V
$T_{OPER}$	Operating Temperature	-55	125	°C
$T_{STG}$	Storage Temperature	-65	150	°C
ESD	ESD Sensitivity (HBM)	2.0	—	kV

## 40-bit Serial to Parallel Driver for GaAs FETs

Rev. V2

### Function Diagram



### Serial Bit Stream Definition<sup>7</sup>

Bit No.	Bit Function	Bit No.	Bit Function
1	RX2-phase 1	21	TX-phase 1-A
2	RX2-phase 2	22	TX-phase 1-B
3	RX2-phase 3	23	TX-phase 2-A
4	RX2-phase 4	24	TX-phase 2-B
5	RX2-phase 5	25	TX-phase 3-A
6	RX2-phase 6	26	TX-phase 3-B
7	RX2-atten 1	27	TX-phase 4-A
8	RX2-atten 2	28	TX-phase 4-B
9	RX2-atten 3	29	TX-phase 5-A
10	RX2-atten 4	30	TX-phase 5-B
11	RX1-phase 1	31	TX-phase 6-A
12	RX1-phase 2	32	TX-phase 6-B
13	RX1-phase 3	33	TX-atten 1-A
14	RX1-phase 4	34	TX-atten 1-B
15	RX1-phase 5	35	TX-atten 2-A
16	RX1-phase 6	36	TX-atten 2-B
17	RX1-atten 1	37	TX-atten 3-A
18	RX1-atten 2	38	TX-atten 3-B
19	RX1-atten 3	39	TX-atten 4-A
20	RX1-atten 4	40	TX-atten 4-B

7. Bit No. 1 should be the first bit going into the serial interface.

### TX Mux Truth Table

Vertical Beam Bits		SNGL_DUAL	
		L	H
TX_STATE	L <sup>8</sup>	A <sup>9</sup>	B <sup>9</sup>
	H <sup>8</sup>	A	A

Horizontal Beam Bits		SNGL_DUAL	
		L	H
TX_STATE	L	B	A
	H	B	B

8. For  $V_{EE} = -5\text{ V}$ , Logic "L" = -5 V, and Logic "H" = 0 V.

9. "A" represents odd bits of the 20-bit TX bit stream, and "B" represents even bits of the 20-bit TX bit stream.

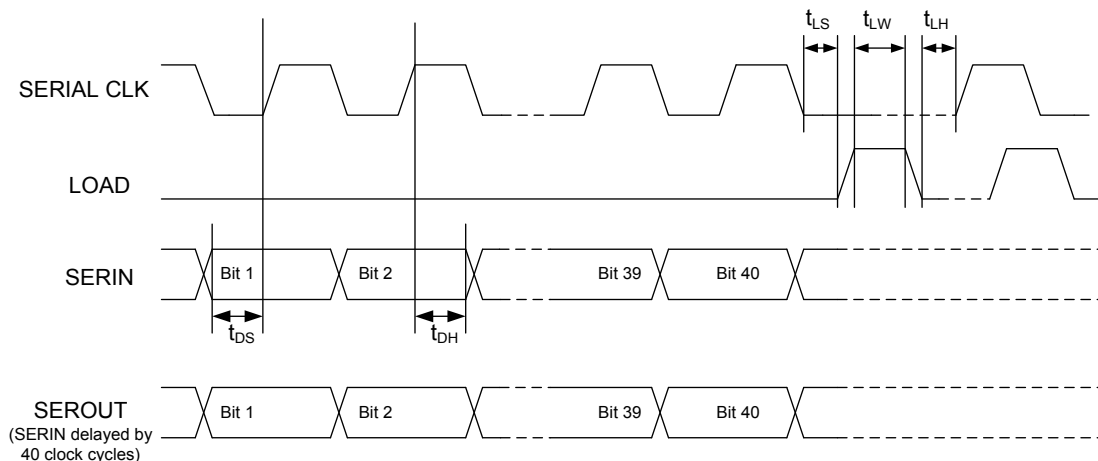
### Handling Procedures

Please observe the following precautions to avoid damage:

### Static Sensitivity

Silicon Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

### Serial Interface Timing Diagram



### Serial Interface Timing Characteristics

Symbol	Parameter	Typical performance			Unit
		-40°C	+25°C	+85°C	
$t_{SCK}$	Min. Serial Clock Period	100	100	100	ns
$t_{DS}$	Min. DATA Set-up Time	20	20	20	ns
$t_{DH}$	Min. DATA Hold Time	20	20	20	ns
$t_{LS}$	Min. LOAD Set-up Time	20	20	20	ns
$t_{LW}$	Min. LOAD Pulse Width	20	20	20	ns
$t_{LH}$	Min. Serial CLK Hold Time from LOAD	20	20	20	ns



M/A-COM Technology Solutions Inc. All rights reserved.

Information in this document is provided in connection with M/A-COM Technology Solutions Inc ("MACOM") products. These materials are provided by MACOM as a service to its customers and may be used for informational purposes only. Except as provided in MACOM's Terms and Conditions of Sale for such products or in any separate agreement related to this document, MACOM assumes no liability whatsoever. MACOM assumes no responsibility for errors or omissions in these materials. MACOM may make changes to specifications and product descriptions at any time, without notice. MACOM makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. MACOM FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. MACOM SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.